**General Description**

The MAX15058 high-efficiency, current-mode, synchronous step-down switching regulator with integrated power switches delivers up to 3A of output current. The device operates from 2.7V to 5.5V and provides an output voltage from 0.6V up to 94% of the input voltage, making the device ideal for distributed power systems, portable devices, and preregulation applications.

The MAX15058 utilizes a current-mode control architecture with a high-gain transconductance error amplifier. The current-mode control architecture facilitates easy compensation design and ensures cycle-by-cycle current limit with fast response to line and load transients.

The MAX15058 offers selectable skip-mode functionality to reduce current consumption and achieve a higher efficiency at light output load. The low R_DS(ON) integrated switches ensure high efficiency at heavy loads while minimizing critical inductances, making the layout design a much simpler task with respect to discrete solutions. Utilizing a simple layout and footprint assures first-pass success in new designs.

The MAX15058 features a 1MHz, factory-trimmed, fixed-frequency PWM mode operation. The high switching frequency, along with the PWM current-mode architecture, allows for a compact, all-ceramic capacitor design.

The MAX15058 offers a capacitor-programmable soft-start reducing inrush current, startup into PREBIAS operations, and a PGOOD open-drain output that can be used as an interrupt and for power sequencing.

The MAX15058 is available in a 9-bump (3 x 3 array), 1.5mm x 1.5mm WLP package and is specified over the -40°C to +85°C temperature range.

**Applications**

- Distributed Power Systems
- Preregulators for Linear Regulators
- Portable Devices
- Notebook Power
- Server Power
- IP Phones

**Features**

- Internal 30mΩ (typ) R_DS(ON) High-Side and 18mΩ (typ) Low-Side MOSFETs at 5V
- Continuous 3A Output Current Over Temperature
- 95% Efficiency with 3.3V Output at 3A
- 1% Output Voltage Accuracy Over Load, Line, and Temperature
- Operates from 2.7V to 5.5V Supply
- Cycle-by-Cycle Overcurrent Protection
- Adjustable Output from 0.6V to Up to 0.94 x V_IN
- Programmable Soft-Start
- Factory-Trimmed, 1MHz Switching Frequency
- Stable with Low-ESR Ceramic Output Capacitors
- Safe-Startup Into Prebiased Output
- External Reference Input
- Skip-Mode Functionality
- Enable Input/Power-Good Output
- Fully Protected Against Overcurrent and Overtemperature
- Input Undervoltage Lockout

**Ordering Information**

<table>
<thead>
<tr>
<th>PART</th>
<th>TEMP RANGE</th>
<th>PIN-PACKAGE</th>
</tr>
</thead>
<tbody>
<tr>
<td>MAX15058EWL+</td>
<td>-40°C to +85°C</td>
<td>9 WLP</td>
</tr>
</tbody>
</table>

*Denotes a lead(Pb)-free/RoHS-compliant package.

**Typical Operating Circuit**

![Typical Operating Circuit Diagram]
MAX15058 High-Efficiency, 3A, Current-Mode Synchronous, Step-Down Switching Regulator

**Absolute Maximum Ratings**

- IN, PGOOD to GND: -0.3V to +6V
- LX to GND: -0.3V to \((V_{IN} + 0.3V)\)
- LX to GND: -1V to \((V_{IN} + 0.3V)\) for 50ns
- EN, COMP, FB, SS/REFIN, SKIP to GND: -0.3V to \((V_{IN} + 0.3V)\)
- LX Current (Note 1): -6A to +6A
- Output Short-Circuit Duration: Continuous
- Continuous Power Dissipation \((T_A = +70^\circ C)\): 9-Bump WLP Multilayer Board
- (derate 14.1mW/°C above \(T_A = +70^\circ C\)): 1127mW
- Operating Temperature Range: -40°C to +85°C
- Storage Temperature Range: -65°C to +150°C
- Soldering Temperature (reflow): +260°C

**Note 1:** LX has internal clamp diodes to GND and IN. Applications that forward bias these diodes should not exceed the IC’s package power dissipation limits.

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Package Information**

<table>
<thead>
<tr>
<th>PACKAGE TYPE: 9 WLP</th>
</tr>
</thead>
<tbody>
<tr>
<td>Package Code</td>
</tr>
<tr>
<td>Outline Number</td>
</tr>
<tr>
<td>Land Pattern Number</td>
</tr>
</tbody>
</table>

**THERMAL RESISTANCE, FOUR-LAYER BOARD**

- Junction to Ambient \((\theta_{JA})\): 71°C/W
- Junction to Case \((\theta_{JC})\): 26°C/W

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a “+”, “#”, or “-” in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.
# MAX15058

High-Efficiency, 3A, Current-Mode Synchronous, Step-Down Switching Regulator

## Electrical Characteristics

(V\textsubscript{IN} = 5V, T\textsubscript{A} = -40°C to +85°C, unless otherwise noted. Typical values are at T\textsubscript{A} = +25°C.) (Note 2)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>IN Voltage Range</td>
<td>V\textsubscript{IN}</td>
<td></td>
<td>2.7</td>
<td>5.5</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>IN Shutdown Supply Current</td>
<td>V\textsubscript{EN} = 0V</td>
<td></td>
<td>0.2</td>
<td>2</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>IN Supply Current</td>
<td>I\textsubscript{IN}</td>
<td>V\textsubscript{EN} = 5V, V\textsubscript{FB} = 0.65V, no switching</td>
<td>1.56</td>
<td>2.3</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>V\textsubscript{IN} Undervoltage Lockout Threshold</td>
<td></td>
<td>LX starts switching, V\textsubscript{IN} rising</td>
<td>2.6</td>
<td>2.7</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>V\textsubscript{IN} Undervoltage Lockout Hysteresis</td>
<td></td>
<td>LX stops switching, V\textsubscript{IN} falling</td>
<td>200</td>
<td></td>
<td>mV</td>
<td></td>
</tr>
<tr>
<td>ERROR AMPLIFIER</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Transconductance</td>
<td>g\textsubscript{MV}</td>
<td></td>
<td>1.5</td>
<td></td>
<td>mS</td>
<td></td>
</tr>
<tr>
<td>Voltage Gain</td>
<td>A\textsubscript{VEA}</td>
<td></td>
<td>90</td>
<td></td>
<td>dB</td>
<td></td>
</tr>
<tr>
<td>FB Set-Point Accuracy</td>
<td>V\textsubscript{FB}</td>
<td>Over line, load, and temperature</td>
<td>594</td>
<td>600</td>
<td>606</td>
<td>mV</td>
</tr>
<tr>
<td>FB Input Bias Current</td>
<td>I\textsubscript{FB}</td>
<td>V\textsubscript{FB} = 0.6V</td>
<td>-500</td>
<td>+500</td>
<td>nA</td>
<td></td>
</tr>
<tr>
<td>COMP to Current-Sense Transconductance</td>
<td>g\textsubscript{MC}</td>
<td></td>
<td>18</td>
<td></td>
<td>A/V</td>
<td></td>
</tr>
<tr>
<td>COMP Clamp Low</td>
<td></td>
<td>V\textsubscript{FB} = 0.65V, V\textsubscript{SS} = 0.6V</td>
<td>0.94</td>
<td></td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>POWER SWITCHES</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>LX On-Resistance, High-Side pMOS</td>
<td></td>
<td></td>
<td>30</td>
<td></td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>LX On-Resistance, Low-Side nMOS</td>
<td></td>
<td></td>
<td>18</td>
<td></td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>High-Side Switch Current-Limit Threshold</td>
<td>I\textsubscript{HSCL}</td>
<td></td>
<td>5</td>
<td></td>
<td>A</td>
<td></td>
</tr>
<tr>
<td>Low-Side Switch Sink Current-Limit Threshold</td>
<td></td>
<td></td>
<td>4</td>
<td></td>
<td>A</td>
<td></td>
</tr>
<tr>
<td>Low-Side Switch Source Current-Limit Threshold</td>
<td></td>
<td></td>
<td>5</td>
<td></td>
<td>A</td>
<td></td>
</tr>
<tr>
<td>LX Leakage Current</td>
<td>V\textsubscript{EN} = 0V</td>
<td></td>
<td>10</td>
<td></td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>RMS LX Output current</td>
<td></td>
<td></td>
<td>3</td>
<td></td>
<td>A</td>
<td></td>
</tr>
<tr>
<td>OSCILLATOR</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Switching Frequency</td>
<td>f\textsubscript{SW}</td>
<td></td>
<td>850</td>
<td>1000</td>
<td>1150</td>
<td>kHz</td>
</tr>
<tr>
<td>Maximum Duty Cycle</td>
<td>D\textsubscript{MAX}</td>
<td></td>
<td>94</td>
<td></td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>Minimum Controllable On-Time</td>
<td></td>
<td></td>
<td>70</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>Slope Compensation Ramp Valley</td>
<td></td>
<td></td>
<td>1.15</td>
<td></td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Slope Compensation Ramp Amplitude</td>
<td>V\textsubscript{SLOPE}</td>
<td>Extrapolated to 100% duty cycle</td>
<td>320</td>
<td></td>
<td>mV</td>
<td></td>
</tr>
</tbody>
</table>

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### Electrical Characteristics (continued)

(V\textsubscript{IN} = 5V, T\textsubscript{A} = -40°C to +85°C, unless otherwise noted. Typical values are at T\textsubscript{A} = +25°C.) (Note 2)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>ENABLE</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>EN Input High Threshold Voltage</td>
<td>( V_{EN} ) rising</td>
<td></td>
<td>1.45</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>EN Input Low Threshold Voltage</td>
<td>( V_{EN} ) falling</td>
<td></td>
<td>0.4</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>EN Input Leakage Current</td>
<td>( V_{EN} = 5V )</td>
<td></td>
<td>0.025</td>
<td></td>
<td></td>
<td>( \mu A )</td>
</tr>
<tr>
<td>SKIP Input Leakage Current</td>
<td>( V_{SKIP} = V_{EN} = 5V )</td>
<td></td>
<td>25</td>
<td></td>
<td></td>
<td>( \mu A )</td>
</tr>
<tr>
<td><strong>SOFT-START, PREBIAS, REFIN</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Soft-Start Current</td>
<td>( I_{SS} )</td>
<td>( V_{SS/REFIN} = 0.45V ), sourcing</td>
<td>10</td>
<td>( \mu A )</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Soft/REFIN Discharge Resistance</td>
<td>( R_{SS} )</td>
<td>( I_{SS/REFIN} = 10mA ), sinking</td>
<td>8.3</td>
<td>( \Omega )</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SS/REFIN Prebias Mode Stop Voltage</td>
<td>( V_{SS/REFIN} ) rising</td>
<td></td>
<td>0.58</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>External Reference Input Range</td>
<td></td>
<td></td>
<td>0</td>
<td>( \text{IN} - 1.8 ) V</td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>HICCUP</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Number of Consecutive Current-Limit Events to Hiccup</td>
<td></td>
<td></td>
<td>8</td>
<td></td>
<td>Events</td>
<td></td>
</tr>
<tr>
<td>Timeout</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1024</td>
<td>Clock Cycles</td>
</tr>
<tr>
<td><strong>POWER-GOOD OUTPUT</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>PGOOD Threshold</td>
<td>( V_{FB} ) rising</td>
<td></td>
<td>0.535</td>
<td>0.555</td>
<td>0.575</td>
<td>V</td>
</tr>
<tr>
<td>PGOOD Threshold Hysteresis</td>
<td>( V_{FB} ) falling</td>
<td></td>
<td>28</td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>PGOOD ( V_{OL} )</td>
<td>( I_{PGOOD} = 5mA, V_{FB} = 0.5V )</td>
<td></td>
<td>20</td>
<td>60</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>PGOOD Leakage</td>
<td>( V_{PGOOD} = 5V, V_{FB} = 0.65V )</td>
<td></td>
<td>0.013</td>
<td></td>
<td></td>
<td>( \mu A )</td>
</tr>
<tr>
<td><strong>THERMAL SHUTDOWN</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Thermal Shutdown Threshold</td>
<td></td>
<td></td>
<td>150</td>
<td></td>
<td></td>
<td>(^\circ)C</td>
</tr>
<tr>
<td>Thermal Shutdown Hysteresis</td>
<td></td>
<td>Temperature falling</td>
<td>20</td>
<td></td>
<td></td>
<td>(^\circ)C</td>
</tr>
</tbody>
</table>

**Note 2:** Specifications are 100% production tested at T\textsubscript{A} = +25°C. Limits over the operating temperature range are guaranteed by design and characterization.
**Typical Operating Characteristics**

($V_{IN} = 5V$, $V_{OUT} = 1.8V$, $I_{LOAD} = 3A$, Circuit of Figure 5, $T_A = +25°C$, unless otherwise noted.)

![Efficiency vs. Load Current (PWM Mode)](image1)

![Efficiency vs. Output Current (Forced PWM)](image2)

![Efficiency vs. Load Current (Skip Mode)](image3)

![Efficiency vs. Output Current (Skip Mode)](image4)

![Switching Frequency vs. Input Voltage](image5)

![Output Voltage vs. Supply Voltage](image6)

![Output Voltage vs. Output Current](image7)

---

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Typical Operating Characteristics (continued)

(V_{IN} = 5V, V_{OUT} = 1.8V, I_{LOAD} = 3A, Circuit of Figure 5, T_A = +25°C, unless otherwise noted.)
Typical Operating Characteristics (continued)

\( V_{IN} = 5V, \ V_{OUT} = 1.8V, \ I_{LOAD} = 3A, \) Circuit of Figure 5, \( T_A = +25^\circ C, \) unless otherwise noted.

- **SOFT-START WAVEFORMS (PWM MODE) \( (I_{OUT} = 3A) \)**
- **SOFT-START WAVEFORMS (SKIP MODE) \( (I_{OUT} = 3A) \)**

- **SHUTDOWN CURRENT vs. INPUT VOLTAGE**

- **SHORT-CIRCUIT HICCUP MODE**

- **RMS INPUT CURRENT vs. INPUT VOLTAGE**

- **FB VOLTAGE vs. TEMPERATURE**

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Typical Operating Characteristics (continued)

\( V_{\text{IN}} = 5\text{V}, V_{\text{OUT}} = 1.8\text{V}, I_{\text{LOAD}} = 3\text{A}, \) Circuit of Figure 5, \( T_{A} = +25^\circ\text{C}, \) unless otherwise noted.

**SOFT-START WAVEFORMS (EXTERNAL REFIN) (PWM MODE)**

- VSS/REFIN: 500mV/div
- VOUT: 1V/div
- VPGOOD: 5V/div
- ILX: 1A/div

**STARTING INTO A PREBIASED OUTPUT**

\( I_{\text{OUT}} = 2\text{A} \)

- VENABLE: 5V/div
- VOUT: 1V/div
- ILX: 1A/div
- VPGOOD: 5V/div

**STARTING INTO A PREBIASED OUTPUT**

\( \text{NO LOAD} \)

- PWM MODE

**STARTING INTO A PREBIASED OUTPUT**

\( \text{NO LOAD} \)

- SKIP MODE

**STARTING INTO A PREBIASED OUTPUT**

\( \text{HIGHER THAN SET OUTPUT} \)

- 1.8V
- 10Ω LOAD AT OUT

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MAX15058 High-Efficiency, 3A, Current-Mode Synchronous, Step-Down Switching Regulator

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Typical Operating Characteristics (continued)
($V_{IN} = 5V, V_{OUT} = 1.8V, I_{LOAD} = 3A, $Circuit of Figure 5, $T_A = +25^\circ C$, unless otherwise noted.)
**Pin Description**

<table>
<thead>
<tr>
<th>BUMP</th>
<th>NAME</th>
<th>FUNCTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>A1</td>
<td>GND</td>
<td>Analog Ground/Low-Side Switch Source Terminal. Connect to the PCB copper plane at one point near the input bypass capacitor return terminal.</td>
</tr>
<tr>
<td>A2</td>
<td>LX</td>
<td>Inductor Connection. Connect LX to the switched side of the inductor. LX is high impedance when the IC is in shutdown mode.</td>
</tr>
<tr>
<td>A3</td>
<td>IN</td>
<td>Input Power Supply. Input supply range is from 2.7V to 5.5V. Bypass with a minimum 10µF ceramic capacitor to GND. See Figures 5 and 6.</td>
</tr>
<tr>
<td>B1</td>
<td>COMP</td>
<td>Voltage Error-Amplifier Output. Connect the necessary compensation network from COMP to GND. See the Closing the Loop: Designing the Compensation Circuitry section.</td>
</tr>
<tr>
<td>B2</td>
<td>SKIP</td>
<td>Skip-Mode Input. Connect to EN to select skip mode or leave unconnected for normal operation.</td>
</tr>
<tr>
<td>B3</td>
<td>EN</td>
<td>Enable Input. EN is a digital input that turns the regulator on and off. Drive EN high to turn on the regulator. Connect to IN for always-on operation.</td>
</tr>
<tr>
<td>C1</td>
<td>FB</td>
<td>Feedback Input. Connect FB to the center tap of an external resistor-divider from the output to GND to set the output voltage from 0.6V up to 94% of ( V_{IN} ).</td>
</tr>
<tr>
<td>C2</td>
<td>SS/REFIN</td>
<td>Soft-Start/External Voltage Reference Input. Connect a capacitor from SS/REFIN to GND to set the startup time. See the Setting the Soft-Start Time section for details on setting the soft-start time. Apply a voltage reference from 0V to ( V_{IN} - 1.5V ) to drive soft-start externally.</td>
</tr>
<tr>
<td>C3</td>
<td>PGOOD</td>
<td>Open-Drain Power-Good Output. PGOOD goes high when FB is above 555mV and pulls low if FB is below 527mV.</td>
</tr>
</tbody>
</table>
MAX15058
High-Efficiency, 3A, Current-Mode Synchronous, Step-Down Switching Regulator

Block Diagram
Detailed Description
The MAX15058 high-efficiency, current-mode switching regulator can deliver up to 3A of output current. The MAX15058 provides output voltages from 0.6V to 0.94 x \( V_{IN} \) from 2.7V to 5.5V input supplies, making the device ideal for on-board point-of-load applications.

The MAX15058 delivers current-mode control architecture using a high-gain transconductance error amplifier. The current-mode control architecture facilitates easy compensation design and ensures cycle-by-cycle current limit with fast response to line and load transients.

The MAX15058 features a 1MHz fixed switching frequency, allowing for all-ceramic capacitor designs and fast transient responses. The high operating frequency minimizes the size of external components. The MAX15058 is available in a 1.5mm x 1.5mm (3 x 3 array) x 0.5mm pitch WLP package.

The MAX15058 offers a selectable skip-mode functionality to reduce current consumption and achieve a higher efficiency at light output loads. The low \( R_{DS(ON)} \) integrated switches (30mΩ high-side and 18mΩ low-side, typ) ensure high efficiency at heavy loads while minimizing critical inductances, making the layout design a much simpler task with respect to discrete solutions. Utilizing a simple layout and footprint assures first-pass success in new designs.

The MAX15058 features 1MHz ±15%, factory-trimmed, fixed-frequency PWM mode operation. The MAX15058 also offers capacitor-programmable, soft-start reducing inrush current, startup into PREBIAS operation, and a PGOOD open-drain output for sequencing with other devices.

Controller Function—PWM Logic
The controller logic block is the central processor that determines the duty cycle of the high-side MOSFET under different line, load, and temperature conditions. Under normal operation, where the current-limit and temperature protection are not triggered, the controller logic block takes the output from the PWM comparator and generates the driver signals for both high-side and low-side MOSFETs. The control logic block controls the break-before-make logic and all the necessary timing.

The high-side MOSFET turns on at the beginning of the oscillator cycle and turns off when the COMP voltage crosses the internal current-mode ramp waveform, which is the sum of the slope compensation ramp and the current-mode ramp derived from inductor current (current-sense block). The high-side MOSFET also turns off if the maximum duty cycle is 94%, or when the current limit is reached. The low-side MOSFET turns on for the remainder of the oscillation cycle.

Starting into a Prebiased Output
The MAX15058 can soft-start into a prebiased output without discharging the output capacitor. In safe prebiased startup, both low-side and high-side MOSFETs remain off to avoid discharging the prebiased output. PWM operation starts when the voltage on SS/REFIN crosses the voltage on FB.

The MAX15058 can start into a prebiased voltage higher than the nominal set point without abruptly discharging the output. Forced PWM operation starts when the SS/REFIN voltage reaches 0.58V (typ), forcing the converter to start. In case of prebiased output, below or above the output nominal set point, if low-side sink current-limit threshold (set to the reduced value of -0.4A (typ) for the first 32 clock cycles and then set to -5A (typ)) is reached, the low-side switch turns off before the end of the clock period, and the high-side switch turns on until one of the following conditions is satisfied:

- High-side source current hits the reduced high-side current limit (0.4A, typ); in this case, the high-side switch is turned off for the remaining time of the clock period.
- The clock period ends. Reduced high-side current limit is activated to recirculate the current into the high-side power switch rather than into the internal high-side body diode, which could be damaged. Low-side sink current limit is provided to protect the low-side switch from excessive reverse current during prebiased operation.

In skip mode operation, the prebias output needs to be lower than the set point.

Enable Input
The MAX15058 features independent device enable control and power-good signal that allow for flexible power sequencing. Drive the enable input (EN) high to enable the regulator, or connect EN to IN for always-on operation. Power-good (PGOOD) is an open-drain output that asserts when \( V_{FB} \) is above 555mV (typ), and deasserts low if \( V_{FB} \) is below 527mV (typ).

Programmable Soft-Start (SS/REFIN)
The MAX15058 utilizes a soft-start feature to slowly ramp up the regulated output voltage to reduce input inrush current during startup. Connect a capacitor from SS/REFIN to GND to set the startup time (see the Setting the Soft-Start Time section for capacitor selection details).
**Error Amplifier**

A high-gain error amplifier provides accuracy for the voltage-feedback loop regulation. Connect the necessary compensation network between COMP and GND (see the Compensation Design Guidelines section). The error-amplifier transconductance is 1.5mS (typ). COMP clamp low is set to 0.94V (typ), just below the slope ramp compensation valley, helping COMP to rapidly return to the correct set point during load and line transients.

**PWM Comparator**

The PWM comparator compares COMP voltage to the current-derived ramp waveform (LX current to COMP voltage transconductance value is 18A/V typ). To avoid instability due to subharmonic oscillations when the duty cycle is around 50% or higher, a slope compensation ramp is added to the current-derived ramp waveform. Confirm the compensation ramp slope (0.3V x 1MHz = 0.3V/µs) is equivalent to half the inductor current downslope in the worst case (load 3A, current ripple 30% and maximum duty-cycle operation of 94%). The slope compensation ramp valley is set to 1.15V (typ).

**Overcurrent Protection and Hiccup**

When the converter output is shorted or the device is overloaded, each high-side MOSFET current-limit event (5A typ) turns off the high-side MOSFET and turns on the low-side MOSFET. On each current-limit event a 3-bit counter is incremented. The counter is reset after three consecutive high-side MOSFETs turn on without reaching current limit. If the current-limit condition persists, the counter fills up reaching eight events. The control logic then discharges SS/REFIN, stops both high-side and low-side MOSFETs, and waits for a hiccup period (1024 clock cycles typ) before attempting a new soft-start sequence. The hiccup mode is also enabled during soft-start time.

**Thermal-Shutdown Protection**

The MAX15058 contains an internal thermal sensor that limits the total power dissipation to protect the device in the event of an extended thermal fault condition. When the die temperature exceeds +150°C (typ), the thermal sensor shuts down the device, turning off the DC-DC converter to allow the die to cool. After the die temperature falls by 20°C (typ), the device restarts, following the soft-start sequence.

**Skip Mode Operation**

The MAX15058 operates in skip mode when SKIP is connected to EN. When in skip mode, LX output becomes high impedance when the inductor current falls below 200mA (typ). The inductor current does not become negative. If during a clock cycle the inductor current falls below the 200mA threshold (during off-time), the low side turns off. At the next clock cycle, if the output voltage is above set point, the PWM logic keeps both high-side and low-side MOSFETs off. If instead the output voltage is below the set point, the PWM logic drives the high-side on for a minimum fixed on-time (300ns typ). In this way the system can skip cycles, reducing frequency of operations, and switches only as needed to service load at the cost of an increase in output voltage ripple (see the Skip Mode Frequency and Output Ripple section). In skip mode, power dissipation is reduced and efficiency is improved at light loads because power MOSFETs do not switch at every clock cycle.

**Applications Information**

**Setting the Output Voltage**

The MAX15058 output voltage is adjustable from 0.6V up to 94% of VIN by connecting FB to the center tap of a resistor-divider between the output and GND (Figure 1). Choose R1 and R2 so that the DC errors due to the FB input bias current (∓500nA) do not affect the output voltage accuracy. With lower value resistors, the DC error is reduced, but the amount of power consumed in the resistor-divider increases. A typical value for R2 is 10kΩ, but values between 5kΩ and 50kΩ are acceptable. Once R2 is chosen, calculate R1 using:

\[ R1 = R2 \times \left( \frac{V_{OUT}}{V_{FB}} - 1 \right) \]

where the feedback threshold voltage, \( V_{FB} = 0.6V \) (typ).

When regulating for an output of 0.6V in skip mode, short FB to OUT and keep R2 connected from FB to GND.

**Inductor Selection**

A high-valued inductor results in reduced inductor ripple current, leading to a reduced output ripple voltage. However, a high-valued inductor results in either a larger physical size or a high series resistance (DCR) and a lower saturation current rating. Typically, choose an inductor value to produce a current ripple equal to 30% of load current. Choose the inductor with the following formula:

\[ L = \frac{V_{OUT}}{f_{SW} \times LIR \times I_{LOAD}} \times \left( 1 - \frac{V_{OUT}}{V_{IN}} \right) \]

where \( f_{SW} \) is the internally fixed 1MHz switching frequency, and LIR is the desired inductor current ratio (typically 200mA (typ)).
set to 0.3). In addition, the peak inductor current, $I_{L_{PK}}$, must always be below the minimum high-side current-limit value, $I_{HSCL}$, and the inductor saturation current rating, $I_{L_{SAT}}$.

Ensure that the following relationship is satisfied:

$$I_{L_{PK}} = |I_{LOAD}| + \frac{1}{2} \Delta I_L < \min(I_{HSCL}, I_{L_{SAT}})$$

### Input Capacitor Selection

The input capacitor reduces the peak current drawn from the input power supply and reduces switching noise in the device. The total input capacitance must be equal to or greater than the value given by the following equation to keep the input ripple voltage within the specification and minimize the high-frequency ripple current being fed back to the input source:

$$C_{IN} = \frac{|I_{LOAD}|}{f_{SW} \times \Delta V_{IN_{RIPPLE}}} \times \frac{V_{OUT}}{V_{IN}}$$

where $\Delta V_{IN_{RIPPLE}}$ is the maximum-allowed input ripple voltage across the input capacitors and is recommended to be less than 2% of the minimum input voltage, $f_{SW}$ is the switching frequency (1MHz), and $I_{LOAD}$ is the output load. The impedance of the input capacitor at the switching frequency should be less than that of the input source so high-frequency switching currents do not pass through the input source, but are instead shunted through the input capacitor.

The input capacitor must meet the ripple current requirement imposed by the switching currents. The RMS input ripple current is given by:

$$I_{RIPPLE} = \left[ \frac{\sqrt{V_{OUT} \times (V_{IN} - V_{OUT})}}{V_{IN}} \right] |I_{LOAD}|$$

where $I_{RIPPLE}$ is the input RMS ripple current.

### Output Capacitor Selection

The key selection parameters for the output capacitor are capacitance, ESR, ESL, and voltage rating. The parameters affect the overall stability, output ripple voltage, and transient response of the DC-DC converter. The output ripple occurs due to variations in the charge stored in the output capacitor, the voltage drop due to the capaci-
tor’s ESR, and the voltage drop due to the capacitor’s ESL. Estimate the output-voltage ripple due to the output capacitance, ESR, and ESL as follows:

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_{\text{SW}} \cdot L} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times \left(R_{\text{ESR\_COUT}} + \frac{1}{8 \times f_{\text{SW}} \times C_{\text{OUT}}}\right)$$

For ceramic capacitors, ESR contribution is negligible:

$$R_{\text{ESR\_OUT}} << \frac{1}{8 \times f_{\text{SW}} \times C_{\text{OUT}}}$$

For tantalum or electrolytic capacitors, ESR contribution is dominant:

$$R_{\text{ESR\_OUT}} >> \frac{1}{8 \times f_{\text{SW}} \times C_{\text{OUT}}}$$

Use these equations for initial output-capacitor selection. Determine final values by testing a prototype or an evaluation circuit. A smaller ripple current results in less output-voltage ripple. Since the inductor ripple current is a factor of the inductor value, the output-voltage ripple decreases with larger inductance. Use ceramic capacitors for low ESR and low ESL at the switching frequency of the converter. The ripple voltage due to ESL is negligible when using ceramic capacitors.

Load-transient response also depends on the selected output capacitance. During a load transient, the output instantly changes by $ESR \times \Delta I_{\text{LOAD}}$. Before the controller can respond, the output deviates further, depending on the inductor and output capacitor values. After a short time, the controller responds by regulating the output voltage back to the predetermined value.

Use higher $C_{\text{OUT}}$ values for applications that require light load operation or transition between heavy load and light load, triggering skip mode, causing output undershooting or overshooting. When applying the load, limit the output undershoot by sizing $C_{\text{OUT}}$ according to the following formula:

$$C_{\text{OUT}} \geq \frac{\Delta I_{\text{LOAD}}}{3f_{\text{CO}} \times \Delta V_{\text{OUT}}}$$

where $\Delta I_{\text{LOAD}}$ is the total load change, $f_{\text{CO}}$ is the regulator unity-gain bandwidth (or zero crossover frequency), and $\Delta V_{\text{OUT}}$ is the desired output undershooting. When removing the load and entering skip mode, the device cannot control output overshooting, since it has no sink current capability; see the Skip Mode Frequency and Output Ripple section to properly size $C_{\text{OUT}}$.

**Skip Mode Frequency and Output Ripple**

In skip mode, the switching frequency ($f_{\text{SKIP}}$) and output ripple voltage ($V_{\text{OUT\_RIPPLE}}$) shown in Figure 2 are calculated as follows:

$t_{\text{ON}}$ is a fixed time (300ns, typ); the peak inductor current reached is:

$$I_{\text{SKIP\_LIMIT}} = \frac{V_{\text{IN}} - V_{\text{OUT}}}{L} \times t_{\text{ON}}$$

![Figure 2. Skip Mode Waveform](maximintegrated.com)
t_{OFF1} is the time needed for inductor current to reach the zero-current crossing limit (~0A):

$$t_{OFF1} = \frac{L \times (I_{\text{SKIP}} - I_{\text{LOAD}})}{V_{\text{OUT}}}$$

During $t_{ON}$ and $t_{OFF1}$, the output capacitor stores a charge equal to (see Figure 2):

$$\Delta Q_{\text{OUT}} = \frac{L \times (I_{\text{SKIP}} - I_{\text{LOAD}})^2 \times \left(\frac{1}{V_{\text{IN}} - V_{\text{OUT}}} + \frac{1}{V_{\text{OUT}}}\right)}{2}$$

During $t_{OFF2}$ ($= n \times t_{\text{CK}}$, number of clock cycles skipped), output capacitor loses this charge:

$$t_{OFF2} = \frac{\Delta Q_{\text{OUT}}}{I_{\text{LOAD}}} = \frac{L \times (I_{\text{SKIP}} - I_{\text{LOAD}})^2 \times \left(\frac{1}{V_{\text{IN}} - V_{\text{OUT}}} + \frac{1}{V_{\text{OUT}}}\right)}{2 \times I_{\text{LOAD}}}$$

Finally, frequency in skip mode is:

$$f_{\text{SKIP}} = \frac{1}{t_{\text{ON}} + t_{\text{OFF1}} + t_{\text{OFF2}}}$$

Output ripple in skip mode is:

$$V_{\text{OUT RIPPLE}} = V_{\text{COUT RIPPLE}} + V_{\text{ESR RIPPLE}} = (I_{\text{SKIP}} - I_{\text{LOAD}}) \times t_{\text{ON}} \times C_{\text{OUT}} + R_{\text{ESR,COUT}} \times (I_{\text{SKIP}} - I_{\text{LOAD}})$$

$$V_{\text{OUT RIPPLE}} = \left[ \frac{L \times (I_{\text{SKIP}} - I_{\text{LOAD}})}{C_{\text{OUT}} \times (V_{\text{IN}} - V_{\text{OUT}})} + R_{\text{ESR,COUT}} \times (I_{\text{SKIP}} - I_{\text{LOAD}}) \right]$$

To limit output ripple in skip mode, size $C_{\text{OUT}}$ based on the above formula. All the above calculations are applicable only in skip mode.

**Compensation Design Guidelines**

The MAX15058 uses a fixed-frequency, peak-current-mode control scheme to provide easy compensation and fast transient response. The inductor peak current is monitored on a cycle-by-cycle basis and compared to the COMP voltage (output of the voltage error amplifier). The regulator’s duty cycle is modulated based on the inductor’s peak current value. This cycle-by-cycle control of the inductor current emulates a controlled current source.

As a result, the inductor’s pole frequency is shifted beyond the gain bandwidth of the regulator. System stability is provided with the addition of a simple series capacitor-resistor from COMP to GND. This pole-zero combination serves to tailor the desired response of the closed-loop system. The basic regulator loop consists of a power modulator (comprising the regulator’s pulse-width modulator, current sense and slope compensation ramps, control circuitry, MOSFETs, and inductor), the capacitive output filter and load, an output feedback divider, and a voltage-loop error amplifier with its associated compensation circuitry. See Figure 1.

The average current through the inductor is expressed as:

$$\overline{I_L} = G_{\text{MOD}} \times \overline{V_{\text{COMP}}}$$

where $\overline{I_L}$ is the average inductor current and $G_{\text{MOD}}$ is the power modulator’s transconductance.

For a buck converter:

$$\overline{V_{\text{OUT}}} = R_{\text{LOAD}} \times \overline{I_L}$$

where $R_{\text{LOAD}}$ is the equivalent load resistor value.

Combining the above two relationships, the power modulator’s transfer function in terms of $\overline{V_{\text{OUT}}}$ with respect to $\overline{V_{\text{COMP}}}$ is:

$$\frac{\overline{V_{\text{OUT}}}}{\overline{V_{\text{COMP}}}} = \frac{\overline{I_L}}{G_{\text{MOD}}} = R_{\text{LOAD}} \times \frac{\overline{I_L}}{G_{\text{MOD}}}$$

The peak current-mode controller’s modulator gain is attenuated by the equivalent divider ratio of the load resistance and the current-loop gain’s impedance. $G_{\text{MOD}}$ becomes

$$G_{\text{MOD}}(\text{DC}) = g_{\text{MC}} \times \frac{1}{\left(1 + \frac{R_{\text{LOAD}}}{f_{\text{SW}} \times L \times [K_S \times (1 - D) - 0.5]}\right)}$$

where $R_{\text{LOAD}} = \overline{V_{\text{OUT}}}/\overline{I_{\text{OUT (MAX)}}}$, $f_{\text{SW}}$ is the switching frequency, $L$ is the output inductance, $D$ is the duty cycle ($V_{\text{OUT}}/V_{\text{IN}}$), and $K_S$ is a slope compensation factor calculated from the following equation:

$$K_S = 1 + \frac{S_{\text{SLOPE}}}{S_N} = 1 + \frac{V_{\text{SLOPE}} \times f_{\text{SW}} \times L \times g_{\text{MC}}}{(V_{\text{IN}} - V_{\text{OUT}})}$$

where:

$$S_{\text{SLOPE}} = \frac{V_{\text{SLOPE}}}{t_{\text{SW}}} = V_{\text{SLOPE}} \times f_{\text{SW}}$$

$$S_N = \frac{(V_{\text{IN}} - V_{\text{OUT}})}{L \times g_{\text{MC}}}$$
As previously mentioned, the power modulator’s dominant pole is a function of the parallel effects of the load resistance and the current-loop gain’s equivalent impedance:

\[
P_{\text{MOD}} = \frac{1}{2\pi C_{\text{OUT}} \times ESR + \left( \frac{1}{R_{\text{LOAD}}} + \left( \frac{K_S \times (1 - D) - 0.5}{f_{SW} \times L} \right)^{-1} \right)}
\]

And knowing that the ESR is typically much smaller than the parallel combination of the load and the current loop:

\[
E_{SR} << \left( \frac{1}{R_{\text{LOAD}}} + \left( \frac{K_S \times (1 - D) - 0.5}{f_{SW} \times L} \right)^{-1} \right)
\]

which can be expressed as:

\[
f_{\text{PMOD}} \approx \frac{1}{2\pi C_{\text{OUT}} \times R_{\text{LOAD}} + \left( \frac{K_S \times (1 - D) - 0.5}{f_{SW} \times L} \right)}
\]

Note: Depending on the application’s specifics, the amplitude of the slope compensation ramp could have a significant impact on the modulator’s dominant pole. For low duty-cycle applications, it provides additional damping (phase lag) at/ near the crossover frequency (see the Closing the Loop: Designing the Compensation Circuitry section). There is no equivalent effect on the power modulator zero, \( f_{Z\text{MOD}} \).

\[
f_{Z\text{MOD}} = f_{Z\text{ESR}} = \frac{1}{2\pi C_{\text{OUT}} \times ESR}
\]
The effect of the inner current loop at higher frequencies is modeled as a double-pole (complex conjugate) frequency term, \( G_{\text{SAMPLING}}(s) \), as shown:

\[
G_{\text{SAMPLING}}(s) = \frac{1}{s^2 + \frac{1}{\pi f_{\text{SW}} Q_C}}
\]

where the sampling effect quality factor, \( Q_C \), is:

\[
Q_C = \frac{1}{\pi K_S (1-D) - 0.5}
\]

And the resonant frequency is:

\[
\omega_{\text{SAMPLING}}(s) = \pi f_{\text{SW}}
\]

or:

\[
f_{\text{SAMPLING}} = \frac{f_{\text{SW}}}{2}
\]

Having defined the power modulator’s transfer function, the total system transfer can be written as follows (see Figure 3):

\[
\text{Gain}(s) = G_{\text{FF}}(s) \times G_{\text{EA}}(s) \times G_{\text{MOD}}(\text{DC}) \times G_{\text{FILTER}}(s) \times G_{\text{SAMPLING}}(s)
\]

where:

\[
G_{\text{FF}}(s) = \frac{R_2}{R_1 + R_2} \left( \frac{sC_{\text{FF}} R_1 + 1}{sC_{\text{FF}} R_1} + 1 \right)
\]

Leaving \( C_{\text{FF}} \) empty, \( G_{\text{FF}}(s) \) becomes:

\[
G_{\text{FF}}(s) = \frac{R_2}{R_1 + R_2}
\]

Also:

\[
G_{\text{EA}}(s) = 10^{AVEA(\text{dB})/20} \left( \frac{sC_C R_C + 1}{sC_C \left( 10^{AVEA(\text{dB})/20} + \frac{9\text{MV}}{R_C} \right) + 1} \right)
\]

which simplifies to:

\[
G_{\text{EA}}(s) = 10^{AVEA(\text{dB})/20} \left( \frac{sC_C R_C + 1}{sC_C \left( 10^{AVEA(\text{dB})/20} + \frac{9\text{MV}}{10^{AVEA(\text{dB})/20} + 1} \right) + 1} \right)
\]

when \( R_C << \frac{10^{AVEA(\text{dB})/20}}{9\text{MV}} \)

\[
G_{\text{FILTER}}(s) = \frac{R_{\text{LOAD}}}{sC_{\text{OUT}} ESR} \left( \frac{1}{sC_{\text{OUT}} \left( \frac{1}{\frac{R_{\text{LOAD}}}{f_{\text{SW}} L} + \frac{1}{K_S (1-D) - 0.5}} \right) + 1} \right)
\]

The dominant poles and zeros of the transfer loop gain are shown below:

\[
f_{P1} = \frac{9\text{MV}}{2\pi 10^{AVEA(\text{dB})/20} C_C}
\]

\[
f_{P2} = \frac{1}{2\pi C_{\text{OUT}} ESR \left( \frac{1}{R_{\text{LOAD}} f_{\text{SW}} L} + \frac{1}{K_S (1-D) - 0.5} \right)}^{-1}
\]

\[
f_{Z1} = \frac{2\pi C_C R_C}{f_{\text{SW}}}
\]

\[
f_{Z2} = \frac{2\pi C_{\text{OUT}} ESR}{f_{\text{SW}}}
\]

The order of pole-zero occurrence is:

\[
f_{P1} < f_{P2} < f_{Z1} < f_{CO} < f_{P3} < f_{Z2}
\]

Under heavy load, \( f_{P2} \), approaches \( f_{Z1} \). Figure 3 shows a graphical representation of the asymptotic system closed-loop response, including dominant pole and zero locations.

The loop response’s fourth asymptote (in bold, Figure 3) is the one of interest in establishing the desired crossover frequency (and determining the compensation component values). A lower crossover frequency provides for stable closed-loop operation at the expense of a slower load- and line-transient response. Increasing the crossover frequency improves the transient response at the (potential) cost of system instability. A standard rule of thumb sets the crossover frequency between 1/10 and 1/5 of the switching frequency. First, select the passive power and decoupling components that meet the application’s requirements. Then, choose the small-signal compensation components to achieve the desired closed-loop frequency response and phase margin as outlined in the Closing the Loop: Designing the Compensation Circuitry section.

**Closing the Loop: Designing the Compensation Circuitry**

1. Select the desired crossover frequency. Choose \( f_{CO} \) approximately 1/10 to 1/5 of the switching frequency (\( f_{SW} \)).

2. Determine \( R_C \) by setting the system transfer’s fourth asymptote gain equal to unity (assuming \( f_{CO} > f_{Z1}, f_{P2}, \text{and} f_{P1} \)) where:
Using $C_{FF}$ the zero-pole order is adjusted as follows:

$$f_{p1} < f_{p2} \leq f_{Z1} < \frac{1}{2\pi f_{FF} R1} < \frac{1}{2\pi f_{FF} (R1||R2)} \approx f_{CO} < f_{p3} < f_{Z2}$$

Confirm the desired operation of $C_{FF}$ empirically. The phase lead of $C_{FF}$ diminishes as the output voltage is a smaller multiple of the reference voltage, e.g., below about 1V. Do not use $C_{FF}$ when $V_{OUT} = V_{FB}$.

**Setting the Soft-Start Time**

The soft-start feature ramps up the output voltage slowly, reducing input inrush current during startup. Size the $C_{SS}$ capacitor to achieve the desired soft-start time, $t_{SS}$, using:

$$C_{SS} = \frac{I_{SS} \times t_{SS}}{V_{FB}}$$

$I_{SS}$, the soft-start current, is 10µA (typ) and $V_{FB}$, the output feedback voltage threshold, is 0.6V (typ). When using large $C_{OUT}$ capacitance values, the high-side current limit can trigger during the soft-start period. To ensure the correct soft-start time, $t_{SS}$, choose $C_{SS}$ large enough to satisfy:

$$C_{SS} \gg C_{OUT} \times \frac{V_{OUT} \times I_{SS}}{(I_{HSC}_{\_} - I_{OUT}) \times V_{FB}}$$

$I_{HSC}_{\_}$ is the typical high-side MOSFET current-limit value.

An external tracking reference with steady-state value between 0V and $V_{IN} - 1.8V$ can be applied to $SS/REFIN$. In this case, connect an RC network from external tracking reference and $SS/REFIN$, as shown in Figure 4. The recommended value for $R_{SS}$ is approximately 1kΩ. $R_{SS}$ is needed to ensure that, during hiccup period, $SS/REFIN$ can be internally pulled down.

When an external reference is connected to $SS/REFIN$, the soft-start must be provided externally.

![Figure 4. RC Network for External Reference at SS/REFIN](https://www.maximintegrated.com/dm/DS22247/fr FIG4.png)
Power Dissipation
The MAX15058 is available in a 9-bump WLP package and can dissipate up to 1127mW at $T_A = +70^\circ C$. When the die temperature exceeds $+150^\circ C$, the thermal-shutdown protection is activated (see the Thermal-Shutdown Protection section).

Layout Procedure
Careful PCB layout is critical to achieve clean and stable operation. It is highly recommended to duplicate the MAX15058 Evaluation Kit layout for optimum performance. If deviation is necessary, follow these guidelines for good PCB layout:

1) Connect the signal and ground planes at a single point immediately adjacent to the GND bump of the IC.
2) Place capacitors on IN and SS/REFIN as close as possible to the IC and the corresponding pad using direct traces.
3) Keep the high-current paths as short and wide as possible. Keep the path of switching current short and minimize the loop area formed by LX, the output capacitors, and the input capacitors.
4) Connect IN, LX, and GND separately to a large copper area to help cool the IC to further improve efficiency.
5) Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close as possible to the IC.
6) Route high-speed switching nodes (such as LX) away from sensitive analog areas (such as FB and COMP).
Chip Information
PROCESS: BICMOS
Revision History

<table>
<thead>
<tr>
<th>REVISION NUMBER</th>
<th>REVISION DATE</th>
<th>DESCRIPTION</th>
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<tr>
<td>0</td>
<td>12/10</td>
<td>Initial release</td>
<td>—</td>
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<tr>
<td>1</td>
<td>3/11</td>
<td>Revised Package Information section.</td>
<td>20</td>
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<tr>
<td>2</td>
<td>7/11</td>
<td>Changed the 1.65mm x 1.65mm, 9-bump package information to 1.5mm x 1.5mm, 9-bump package information. Inserted Typical Operating Circuit on page one.</td>
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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated’s website at www.maximintegrated.com.

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